



# SIU32S Rugged COTS Systems

## 3U OpenVPX Sensor Interface Unit

### MOSA/SOSA™-aligned Multiprocessing, Video, I/O and Communication System

The SIU32S is a configurable Modular Open Systems Approach (MOSA) rugged system ideally suited to support a wide range of Mil-Aero applications that require processing, video, high-density I/O, communications and Ethernet switching. The SIU32S leverages NAI's Configurable Open Systems Architecture™ (COSA®) 3U OpenVPX SOSA™-aligned boards, XMC's and smart function modules to deliver off-the-shelf solutions that accelerate deployment of SWaP-optimized systems in air, land and sea applications.

### Versatile & Scalable Rugged Architecture for Demanding Embedded System Applications

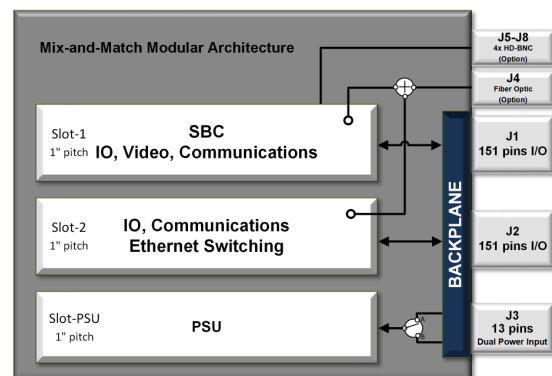
Including: Mission Computing, Vehicle Management System (VMS), Actuator Interface Unit (AIU), IO Adapter (IOA), Data Acquisition (DAQ), Fire Control & Targeting System (FCTS), Remote Data Concentrator (RDC), Data Concentrator Unit (DCU), Remote Interface Unit (RIU), Health and Usage Monitoring System (HUMS), Aircraft Interface Unit (AIU).



Conduction-Cooled SIU32S



Air/Convection-Cooled SIU32S



## Features

- **2x 3U SOSA™ OpenVPX™ Card Slots**
  - Supports up to 6 Video, I/O and/or communication smart function modules
  - 100+ modules to choose from
  - Frame Grabber XMC (VS2)
- **Local or External SBC Host I/F capable**
  - Processor Options: Freescale PowerPC™ QorIQ® T2080, Intel® Core™ i7 or Intel® Xeon® W (Tiger Lake), ARM® Cortex®-A53 or -A72
  - SBC-less remote interface supported via Ethernet connection to your mission computer
- **Configurable I/O Communications and Processing Capabilities**
- **COTS/NDI Sense & Response system**
- **COSA® Architecture**
  - Supports MOSA, SOSA™ and the FACE® technical standards
- **Third Party Board Support (contact factory)**
  - E.g. WOLF NVIDIA RTX™ GPU
- **Reduced SWaP Footprint**
  - **Conduction-Cooled (CC)**
    - 6.0" (W) x 4.6" (H) x 9.5" (D)
    - ~6.6 lbs.
  - **Air/Convection-Cooled (AC)**
    - 6.2" (W) x 4.8" (H) x 9.5" (D)
    - ~6.9 lbs.
    - Contact factory for application review & availability
- **3U VPX CCA Weight**
  - 2.2 lbs. for PSU
  - 1.35 lbs. SBC or IO CCA
- **Dedicated HD38999 I/O Connectors**
- **1" Pitch Slots For All 3U Modules (Cards)**
- **Dual 28 VDC input (nominal) PSU** (Power dissipation is configuration dependent)
  - Dual power input within single connector
  - 50 W typ. (up to 90 W capable)
    - Depending on environment
  - 50 ms (min.) PSU hold-up option
- **Supports Multiple Operating Systems (SBC dependent)**
  - Wind River® Helix™ Virtualization Platform, Wind River® Linux, VxWorks®, VxWorks® Cert Edition, DDC-I Deos™ OS, Lynx MOSA.ic, Xilinx PetaLinux, Ubuntu Linux®
- **Enhanced Capabilities Support (options)**
  - 4x HD-BNC connectors for SDI video input/output (VS2)
  - Dedicated Fiber Optic connector (for Ethernet Switch, TSN, etc.)
- **Continuous Background Built-In-Test (BIT)**
  - Supported by SBC & MFIO/smart modules
- **Environmental and EMI/EMC Specifications**
  - Operating temp: -40°C to +71°C at baseplate, conduction-cooled
  - Air/convection-cooled version option
  - MIL-STD-461\*
  - MIL-STD-810
  - MIL-STD-1275
  - MIL-STD-704

\*MIL-STD-461 requires properly shielded cables and system grounding practices.

**SIU32S Accessories**

Part Number	Description
SIU32S-CONN-KIT	Mating Connector Kit (connector and associated pins only). Includes a set of HD38999 151-pin I/O Connectors (for J1-J2) and Power Connector (for J3).
250-130	Mating Fiber Optic OM3 Cable Assembly (NIUX, SIU3XS), 48 inches long. MT 38999 11-01 chassis connector to industry standard MPO/MTP®-12 male (option for J4).
07-0148	Mating Cable Assembly, BNC Plug to HD-BNC Plug, 75 Ohm, Belden 4855R, 78.7 inches. Suitable for SDI video (option for J5, J6, J7, or J8).
SIU32S-XXXXXX-CBL-KIT	Mating Cable Kit; unique and defined for a specific SIU32S part number configuration (contact factory: -XXXXXX is TBD). Used with 44PIN-DEVELOPMENT-BD.
44PIN-DEVELOPMENT-BD	Development I/O Module Break-out/Connector Board Used with SIU32S-XXXXXX-CBL-KIT assembled with NAI Harwin 44-pin receptacles – one Break-out/Connector Board is required for each function module.

## Select up to 6 independent functions for your application with up to 2 card slots

I/O Boards and Single Board Computers						
Type	Model	Description	Type	Model	Description	
Single Board Computers	<a href="#">68ARM1</a>	3U OpenVPX ARM® Cortex®-A9 Single Board Computer	Single Board Computers	<a href="#">68PPC3</a>	3U OpenVPX, Single Board Computer, Power PC Processor	
	<a href="#">68ARM2</a>	3U OpenVPX, Single Board Computer, Xilinx Zynq® UltraScale+™	High Density I/O Boards	<a href="#">68CB6</a>	3U VPX Combination I/O & Communications Board	
	<a href="#">68ARM4</a>	3U OpenVPX SOSA™-Aligned Single Board Computer NXP Layerscape LX2 Processor Family (8, 12 or 16 Cortex®-A72 Cores)		<a href="#">68DT1</a>	3U OpenVPX Multi-channel Discrete I/O Board	
	<a href="#">68INT4</a>	3U OpenVPX, Single Board Computer, Intel Xeon Quad-core E3-1505LV6 @ 2.2 GHz	Multifunction I/O Boards	<a href="#">68G5</a>	3U OpenVPX I/O and Communications Board	
	<a href="#">68INT5</a>	3U OpenVPX, Single Board Computer, Intel Xeon six-core E-2276ME @ 2.8 GHz		<a href="#">68G5E</a>	3U OpenVPX Ethernet Switch and Multifunction I/O Board	
	<a href="#">68INT6</a>	3U OpenVPX™ SOSA™-Aligned SBC with Intel® Core™ i7-118xGRE Certifiable Processor (Tiger Lake)		<a href="#">68G5P</a>	3U OpenVPX Multifunction I/O Board with External PCIe & SATA II I/F	
	<a href="#">68INT6H</a>	3U OpenVPX™ SOSA™-Aligned Single Board Computer Intel® Xeon® Octal Core W-11865MRE Processor (Tiger Lake)		<a href="#">68G6</a>	3U OpenVPX, MFIO End Point with local Xilinx Zynq UltraScale+ processing capability	
	<a href="#">68PPC2</a>	3U OpenVPX, Single Board Computer, NXP® QorIQ® T2080 Quad-Core e6500 @1.5 GHz	Rugged Power Supplies	<a href="#">VPX68</a>	DC/DC 3U 1.0" Pitch VITA 62 Power Converter meets MIL-STD-704A-F	
Smart Function Module						
Type	Module Category		Type	Module Category		
Combination Modules	<a href="#">A-to-D &amp; D-to-A</a>		Communication Modules	<a href="#">MIL-STD-1553B</a>		
	<a href="#">MIL-STD-1553B &amp; ARINC-429/575</a>			<a href="#">MIL-STD-1760</a>		
	<a href="#">MIL-STD-1553B &amp; Prog. Discrete IO</a>			<a href="#">Serial Communications</a>		
Measurement & Simulation Modules	<a href="#">AC Reference</a>			I/O Modules	<a href="#">Time-Triggered Ethernet</a>	
	<a href="#">IRIG Timecode Receiver and Generator</a>		<a href="#">Analog-to-Digital</a>			
	<a href="#">LVDT RVDI Measurement and Simulation</a>		<a href="#">Chip Detector and Fuzz Burn</a>			
	<a href="#">Pulse Timer Receiver and Generator</a>		<a href="#">Digital IO - Differential Transceiver</a>			
	<a href="#">Strain Gauge Measurement</a>		<a href="#">Digital IO - TTL/CMOS</a>			
	<a href="#">Synchro Resolver Measurement and Simulation</a>		<a href="#">Digital-to-Analog</a>			
	<a href="#">Thermocouple and RTD Measurement</a>		<a href="#">Discrete IO - Multichannel, Programmable</a>			
Communication Modules	<a href="#">ARINC Communications</a>				<a href="#">Relay</a>	
	<a href="#">CANBus Communications</a>				<a href="#">Variable Reluctance</a>	
	<a href="#">Ethernet NIC Interface</a>		Chassis Management (ChM)		<a href="#">Chassis Management</a>	
	<a href="#">Ethernet Switch</a>		Storage	<a href="#">SATA Solid State Drive (SSD)</a>		
	<a href="#">IEEE 1394 (FireWire)</a>					

**Architected for Versatility**

NAI's Configurable Open Systems Architecture™ (COSA®) offers a choice of over 100 smart I/O, communications, or Ethernet switch functions, providing the highest packaging density and greatest flexibility of ruggedized embedded product solutions in the industry. Preexisting, fully-tested functions can be combined in an unlimited number of ways quickly and easily.

**One-Source Efficiencies**

Eliminate man-months of integration with a configured, field-proven system from NAI. Specification to deployment is a seamless experience as all design, state-of-the-art manufacturing, assembly and test are performed - by one trusted source. All facilities are located within the U.S. and optimized for high-mix/low volume production runs and extended lifecycle support.

**Product Lifecycle Management**

From design to production and beyond, NAI's product lifecycle management strategy ensures the long-term availability of COTS products through configuration management, technology refresh and obsolescence component purchase and storage.

*All specifications are subject to change without notice. All product and company names are trademarks or registered trademarks of their respective holders*

